

LINEAR TECHNOLOGY MATERIALS DECLARATION

ltc3208euh#trpbf

(Engineering Calculation)

QFN 5mm X 5mm Exp. Pad

(printed on: 2020-07-11 17:01:58)

TOTAL MASS (g) : 0.064534

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.002039	1000000	31595.6132812		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.028382	975000	439797.34375		
		Iron (Fe)	7439-89-6	0.000699	24000	10831.4550781		
		Phosphorus (P)	7723-14-0	0.000009	300	139.460800171		
		Zinc (Zn)	7440-66-6	0.000020	700	309.912872314		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.029110	1000000	451078.15625		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.001398	1000000	21667.1816406		
		External Plating Total:				0.001398	1000000	21667.1816406
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000635	1000000	9839.73339844		
Internal Plating Total:				0.000635	1000000	9839.73339844		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000920	750000	14255.9921875		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000307	250000	4757.16259766		
Die Attach Total:				0.001227	1000000	19013.1542969		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.003888	130000	60247.0585938		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.025723	860000	398594.40625		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000299	10000	4633.19775391		
		Encapsulation Total:				0.029910	1000000	463474.6875
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000215	1000000	3331.56323242		
					TOTAL MASS (g) :	0.064534		